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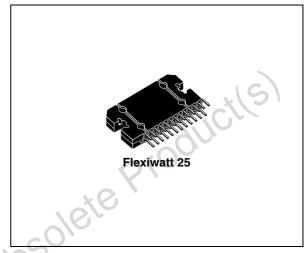
# 4 x 45W quad bridge car radio amplifier

### **Features**

- High output power:
  - $-4 \times 45 \text{ W} / 4 \Omega \text{ max}.$
  - 4 x 28 W /4  $\Omega$  @ 14.4 V, 1 kHz, 10 %
- Low distortion
- Low output noise
- Standby function
- Mute function
- Automute at min. supply voltage detection
- Low external component count:
  - Internally fixed gain (26 dB)
  - No external compensation
  - No bootstrap capacitors
- Clipping detector
- Diagnostic facility for:
  - Out to GND short
  - Out to V<sub>S</sub> short
  - Thermal shutdown

#### **Protections**

- Output short circuit to GND, to V<sub>S</sub>, across the load
- Very inductive loads
- Overrating chip temperature with soft thermal limiter



- Load dump voltage
- Fortuitous open GND
- Reversed battery
- ESD

### **Description**

The TDA7389 is an AB class audio power amplifier, packaged in Flexiwatt 25 and designed for high end car radio applications.

Based on a fully complementary PNP/NPN configuration the TDA7389 allows a rail to rail output voltage swing with no need of bootstrap capacitors.

Table 1. Device summary

Order code	Package	Packing
TDA7389	Flexiwatt 25	Tube

Contents TDA7389

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# 1 Pin connection and block diagrams

Figure 1. Block diagram

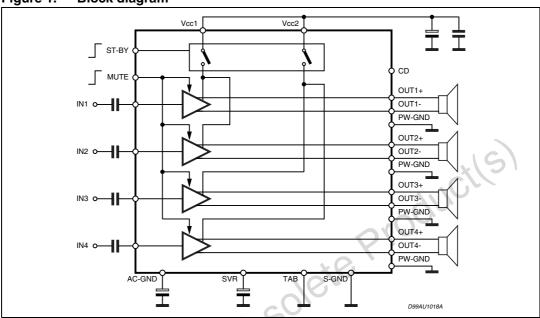
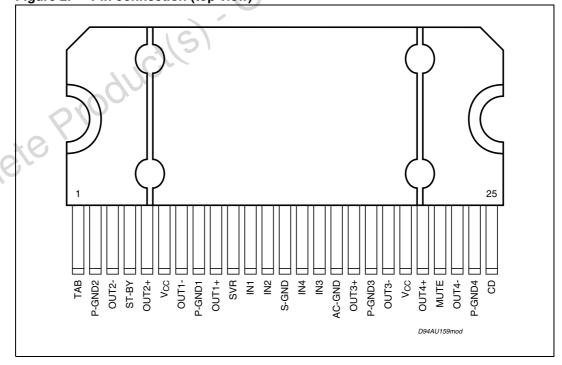


Figure 2. Pin connection (top view)



#### **Electrical specifications** 2

#### 2.1 **Absolute maximum ratings**

Table 2. **Absolute maximum ratings** 

Symbol	Parameter	,	Value	Uı	nit
V <sub>S</sub>	Operating supply voltage	18		\	/
V <sub>S (DC)</sub>	DC supply voltage	28		\	/
V <sub>S (pk)</sub>	Peak supply voltage (t = 50 ms)		50	\	/
I <sub>O</sub>	Output peak current: Repetitive (duty cycle 10 % at f = 10 Hz) Non repetitive (t = 100 µs)		4.5 5.5	315	
P <sub>tot</sub>	Power dissipation, (T <sub>case</sub> = 70 °C)	80		٧	٧
T <sub>j</sub>	Junction temperature	150 °C		С	
T <sub>stg</sub>	Storage temperature	- 55 to 150 °C		С	
Thermal data Table 3. Thermal data					
Symbol	Parameter		Value		Unit

#### Thermal data 2.2

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>th j-case</sub>	Thermal resistance junction to case max.	1	°C/W

#### **Electrical characteristics** 2.3

Table 4. **Electrical characteristics** 

 $(V_S = 14.4V; f = 1KHz; R_g = 600\Omega; R_L = 4\Omega; T_{amb} = 25^{\circ}C;$  Refer to the test and application diagram (*Figure 14*), unless otherwise specified.)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
I <sub>q1</sub>	Quiescent current	$R_L = \infty$		150	350	mA
V <sub>OS</sub>	Output offset voltage	Play mode			±80	mV
d۷	During mute on/off output offset voltagef	ITU R-ARM weighted	-10		10	mV
dV <sub>OS</sub>	During standby on/off output offset voltage	see Figure 13	-50		50	111 <b>V</b>
G <sub>v</sub>	Voltage gain		25	26	27	dB
ΔG <sub>v</sub>	Channel gain unbalance				±1	dB
Po	Output power	THD = 10 %; V <sub>S</sub> = 14.4 V	26	28		W
P <sub>o max</sub>	Max.output power <sup>(1)</sup>	V <sub>S</sub> = 14.4 V	41	45		W

Table 4. **Electrical characteristics (continued)** (V<sub>S</sub> = 14.4V; f = 1KHz; R<sub>g</sub> =  $600\Omega$ ; R<sub>L</sub> =  $4\Omega$ ; T<sub>amb</sub> =  $25^{\circ}$ C; Refer to the test and application diagram (*Figure 14*), unless otherwise specified.)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
THD	Distortion	$P_0 = 4W$		0.04	0.10	%
	Outrut mains	"A" Weighted		50	70	μV
e <sub>No</sub>	Output noise	Bw = 20 Hz to 20 kHz		70	100	μV
SVR	Supply voltage rejection	f = 100 Hz; V <sub>r</sub> = 1 V <sub>rms</sub>	50	75		dB
f <sub>ch</sub>	High cut-off frequency	$P_0 = 0.5 \text{ W}$	100	200		KHz
R <sub>i</sub>	Input Impedance		70	100	150	ΚΩ
	Cross talls	f = 1 kHz; P <sub>o</sub> = 4 W	60	75	2/0	dB
C <sub>T</sub>	Cross talk	f = 10 kHz; P <sub>o</sub> = 4 W		60	$C_{I'I}$	dB
	Standby current	V <sub>St-by</sub> = 1.2 V		70/	50	μА
I <sub>SB</sub>	consumption	V <sub>St-by</sub> = 0 V	01/	)	25	
I <sub>pin4</sub>	Standby pin current	V <sub>St-by</sub> = 1.2 to 2.6 V			±1	μΑ
V <sub>SB out</sub>	Standby Out threshold voltage	(Amp: ON)	2.6			V
V <sub>SB IN</sub>	Standby In threshold voltage	(Amp: OFF)			1.2	V
A <sub>M</sub>	Mute attenuation	P <sub>Oref</sub> = 4 W	80	90		dB
V <sub>M out</sub>	Mute Out threshold voltage	(Amp: play)	2.6			V
V <sub>M in</sub>	Mute In threshold voltage	(Amp: mute)			1.2	V
V <sub>AM in</sub>	V <sub>S</sub> automute threshold	(Amp: mute); Att $\geq$ 80 dB; $P_{Oref} = 4 \Omega$ (Amp: Play); Att < 0.1 dB; $P_0 = 0.5 \text{ W}$		7.6	6.5 8.5	V
I <sub>pin22</sub>	Muting pin current	V <sub>MUTE</sub> = 1.2 V (Source current)	5	11	20	μA
		V <sub>MUTE</sub> = 2.6 V	-5	-	-20	1
Clipping de	tector			•		•
CD <sub>LK</sub>	Clip det high leakage current	CD Off			1	μΑ
CD <sub>SAT</sub>	Clip det sat voltage	DC On; I <sub>CD</sub> = 1m A		0.2	0.4	V
CD <sub>THD</sub>	Clip det THD level	P <sub>0</sub> > 16 W			2	%

<sup>1.</sup> Saturated square wave output.

### 2.4 Electrical characteristic curves

Figure 3. Quiescent current vs. supply voltage

Figure 4. Quiescent output voltage vs. supply voltage

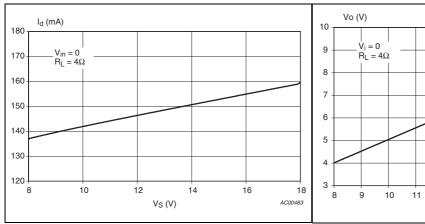
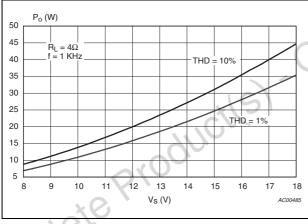


Figure 5. Output power vs. supply voltage

Figure 6. Maximum output power vs. supply voltage



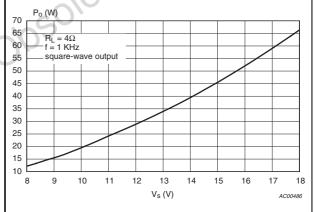
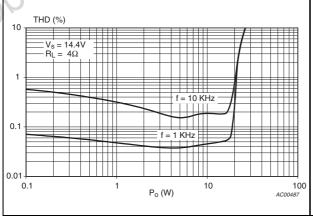


Figure 7. Distortion vs. output power

Figure 8. Distortion vs. frequency



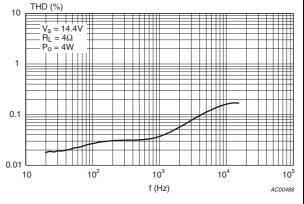


Figure 9. Supply voltage rejection vs. frequency

Figure 10. Crosstalk vs. frequency

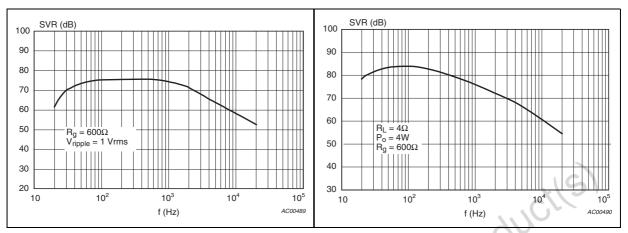


Figure 11. Output noise vs. source resistance Figure 12. Power dissipation & efficiency vs. output power

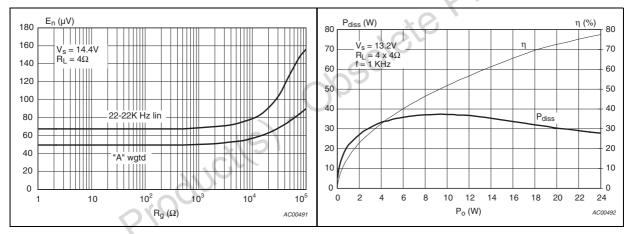
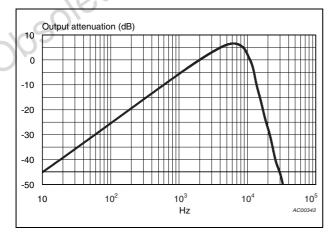
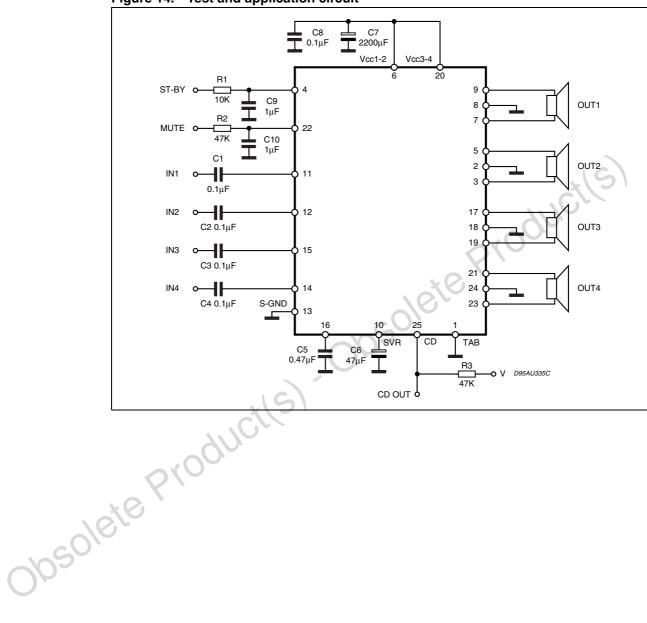


Figure 13. ITU R-ARM frequency response, weighting filter for transient pop



## 2.5 Test and application circuit

Figure 14. Test and application circuit



TDA7389 Application hints

## 3 Application hints

Ref. to the circuit of Figure 14.

### 3.1 SVR

Besides its contribution to the ripple rejection, the SVR capacitor governs the turn ON/OFF time sequence and, consequently, plays an essential role in the pop optimization during ON/OFF transients.

To conveniently serve both needs, **its minimum recommended value is 22μF**, 47μF can be used to optimize pop performances.

### 3.2 Input stage

The TDA7389's inputs are ground-compatible and can stand very high input signals (± 8Vpk) without any performances degradation.

If the standard value for the input capacitors (0.1 $\mu$ F) is adopted, the low frequency cut-off will amount to 16 Hz.

The input capacitors should be 1/4 of the capacitor connected to AC-GND pin for optimum pop performances.

### 3.3 Standby and muting

Standby and Muting facilities are both 3.3V CMOS-compatible. If unused, a straight connection to  $V_s$  of their respective pins would be admissible.

Conventional/low-power transistors can be employed to drive muting and stand-by pins in absence of true CMOS ports or microprocessors. R-C cells have always to be used in order to smooth down the transitions for preventing any audible transient noises.

Since a DC current of about 10 $\mu$ A normally flows out of pin 23, the maximum allowable muting-series resistance (R<sub>2</sub>) is 70 k $\Omega$ , which is sufficiently high to permit a muting capacitor reasonably small (about 1 $\mu$ F).

If  $R_2$  is higher than recommended, the involved risk will be that the voltage at pin 23 may rise to above the 1.2V threshold voltage and the device will consequently fail to turn OFF when the mute line is brought down.

About the standby, the time constant to be assigned in order to obtain a virtually pop-free transition has to be slower than 2.5V/ms.

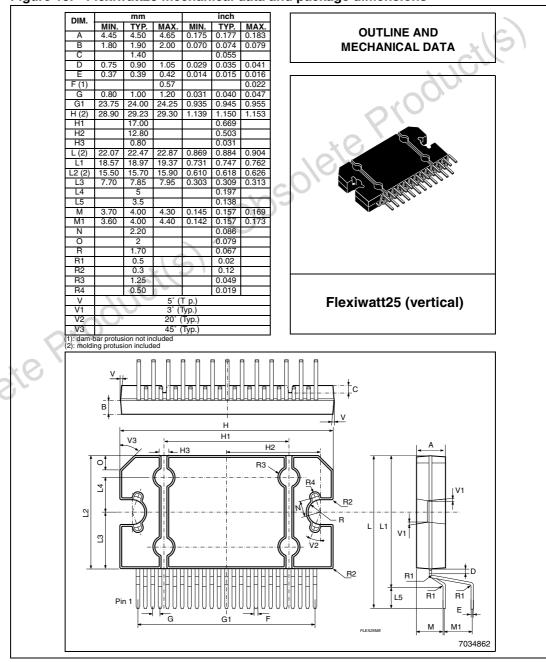
Package information TDA7389

## 4 Package information

In order to meet environmental requirements, ST (also) offers these devices in ECOPACK<sup>®</sup> packages. ECOPACK<sup>®</sup> packages are lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 15. Flexiwatt25 mechanical data and package dimensions



TDA7389 Revision history

# 5 Revision history

Table 5. Document revision history

Date	Revision	Changes
09-Nov-2007	1	Initial release.
20-Oct-2008	2	Updated the Table 3: Thermal data on page 6.
17-Sep-2013	3	Updated Disclaimer.

Obsolete Product(s) - Obsolete Product(s)

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